

P-CHANNEL MOS FIELD EFFECT TRANSISTOR
 FOR SWITCHING

DESCRIPTION

The μ PA1812 is a switching device which can be driven directly by a 4.0-V power source.

The μ PA1812 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- ★ Can be driven by a 4.0-V power source
 - ★ Low on-state resistance
- $R_{DS(on)1} = 39 \text{ m}\Omega \text{ MAX. (} V_{GS} = -10 \text{ V, } I_D = -2.5 \text{ A)}$
 $R_{DS(on)2} = 63 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.5 \text{ V, } I_D = -2.5 \text{ A)}$
 $R_{DS(on)3} = 69 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.0 \text{ V, } I_D = -2.5 \text{ A)}$

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1812GR-9JG	Power TSSOP8

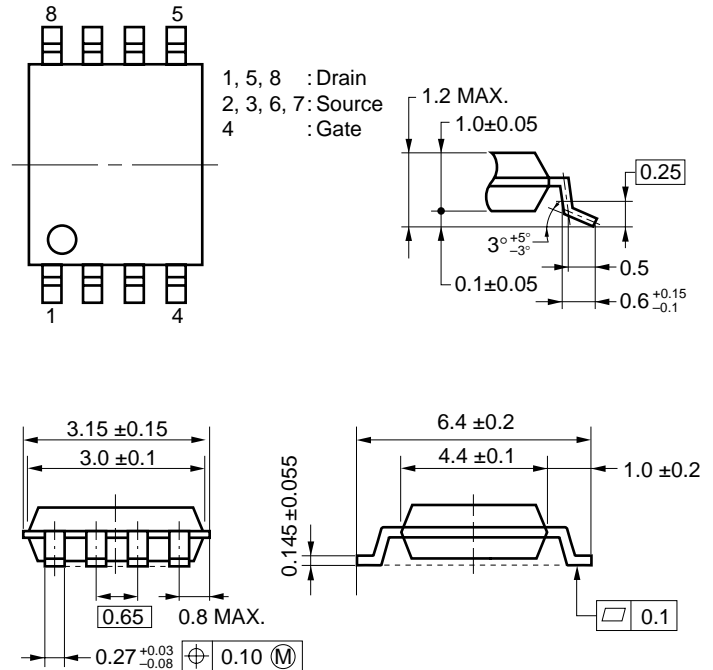
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Drain to Source Voltage	V_{DSS}	-30	V
Gate to Source Voltage	V_{GSS}	-20/+5	V
Drain Current (DC)	$I_{D(DC)}$	± 5.0	A
Drain Current (pulse) ^{Note1}	$I_{D(pulse)}$	± 20	A
Total Power Dissipation ^{Note2}	P_T	2.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

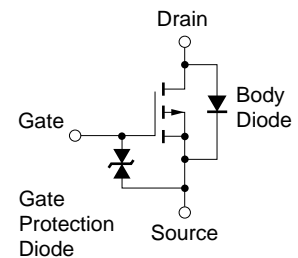
- Notes 1. $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$
 2. Mounted on ceramic substrate of $5000 \text{ mm}^2 \times 1.1 \text{ mm}$

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

PACKAGE DRAWING (Unit : mm)



EQUIVALENT CIRCUIT

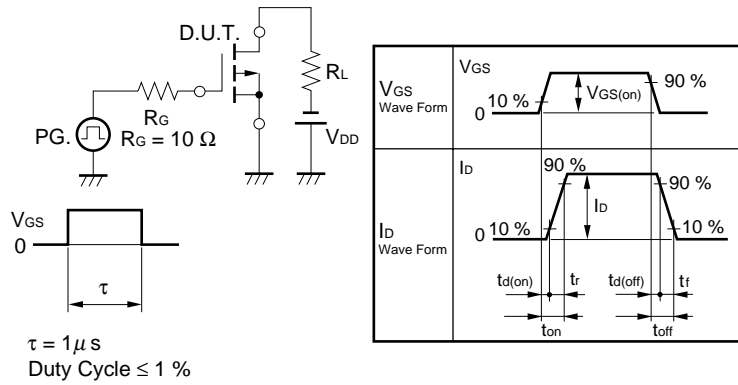


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 Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

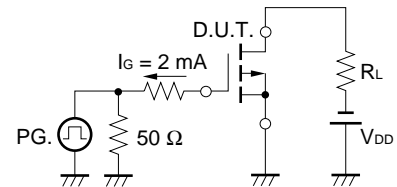
★ ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V			-10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = -10 V, I _D = -1 mA	-1.0	-1.6	-2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = -10 V, I _D = -2.5 A	1	8		S
Drain to Source On-state Resistance	R _{DS(on)1}	V _{GS} = -10 V, I _D = -2.5 A		29	39	mΩ
	R _{DS(on)2}	V _{GS} = -4.5 V, I _D = -2.5 A		46	63	mΩ
	R _{DS(on)3}	V _{GS} = -4.0 V, I _D = -2.5 A		52	69	mΩ
Input Capacitance	C _{iSS}	V _{DS} = -10 V		1500		pF
Output Capacitance	C _{oSS}	V _{GS} = 0 V		550		pF
Reverse Transfer Capacitance	C _{rSS}	f = 1 MHz		270		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = -10 V		30		ns
Rise Time	t _r	I _D = -2.5 A		160		ns
Turn-off Delay Time	t _{d(off)}	V _{GS(on)} = -10 V		110		ns
Fall Time	t _f	R _G = 10 Ω		80		ns
Total Gate Charge	Q _G	V _{DS} = -24 V		31		nC
Gate to Source Charge	Q _{GS}	I _D = -5.0 A		4		nC
Gate to Drain Charge	Q _{GD}	V _{GS} = -10 V		8		nC
Diode Forward Voltage	V _{F(S-D)}	I _F = 5.0 A, V _{GS} = 0 V		0.76		V

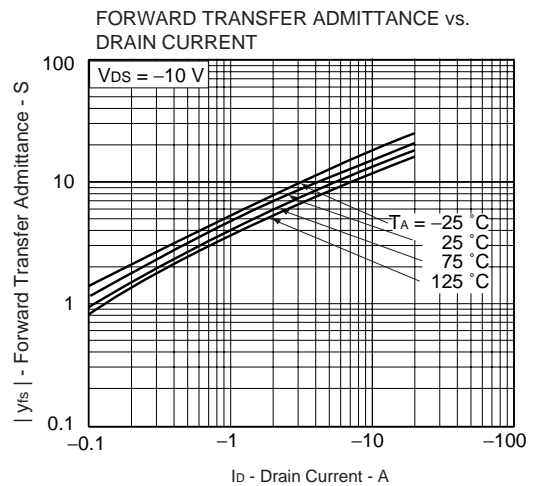
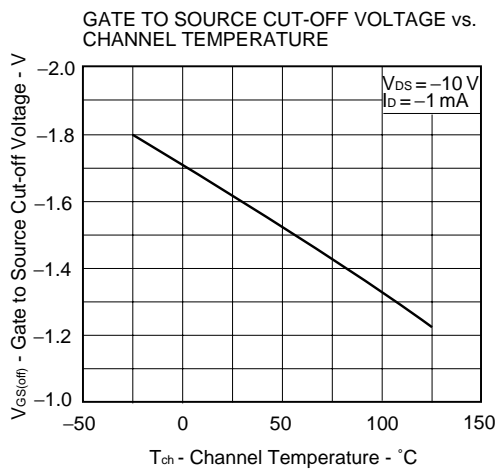
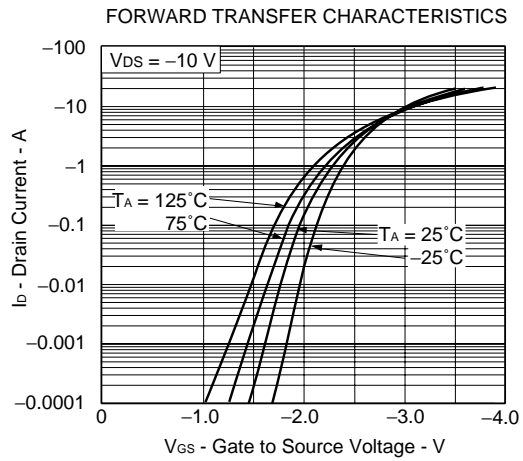
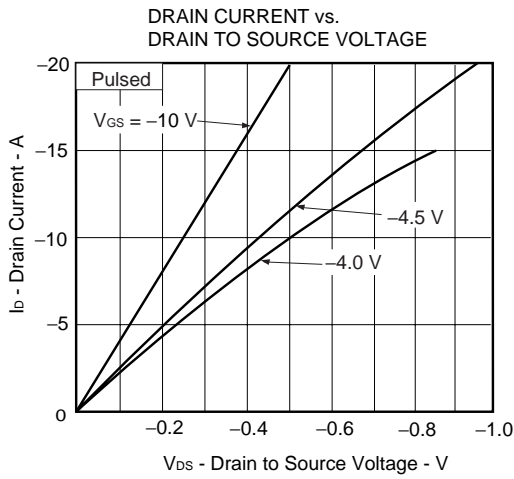
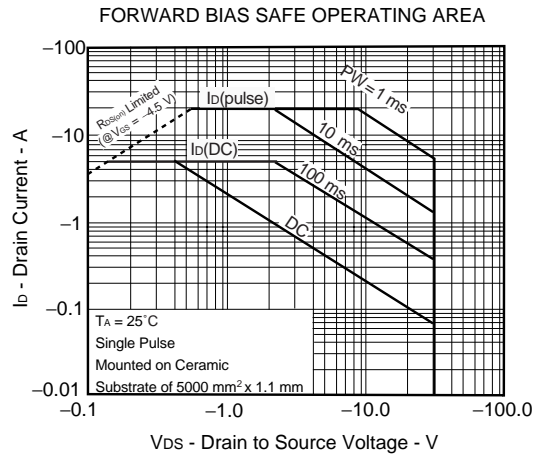
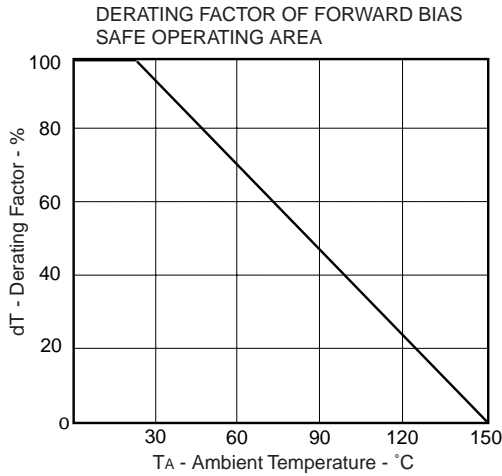
TEST CIRCUIT 1 SWITCHING TIME

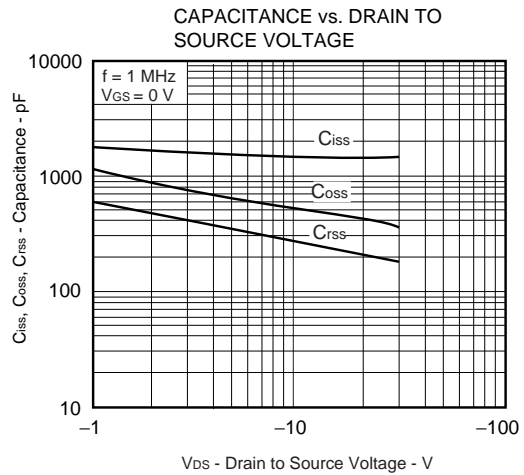
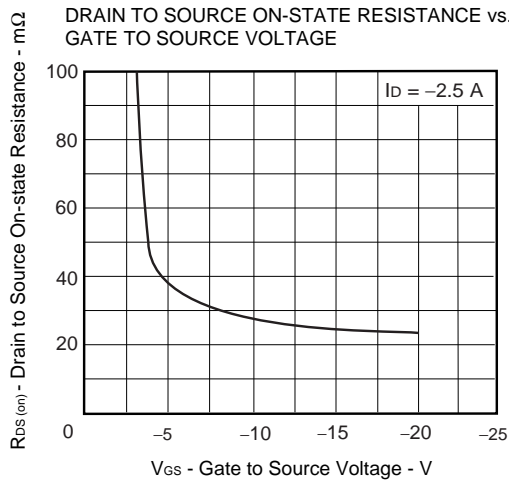
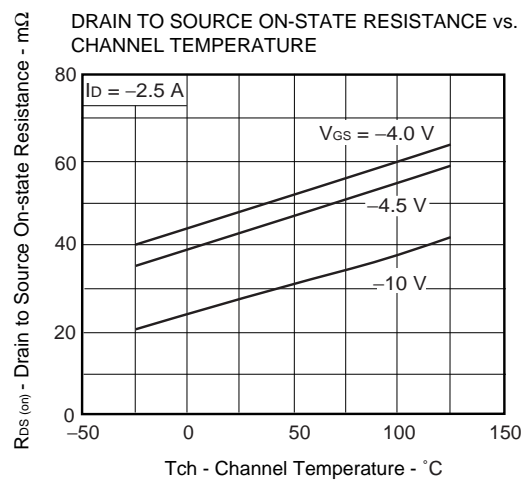
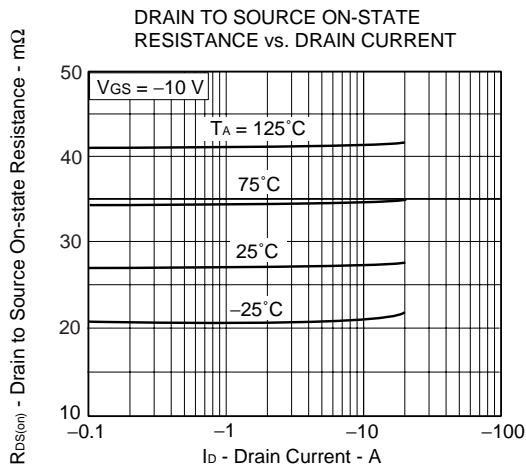
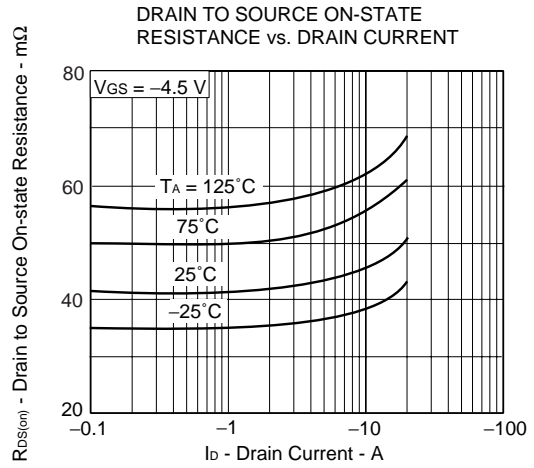
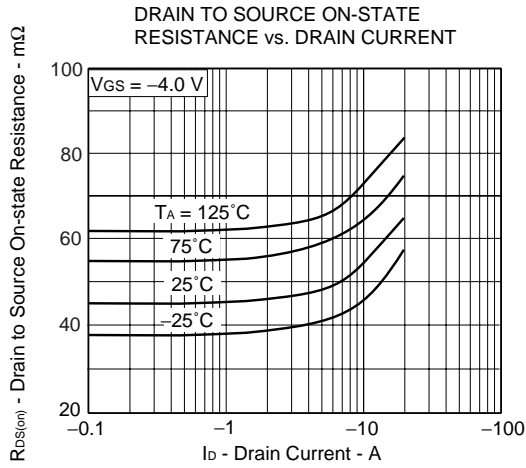


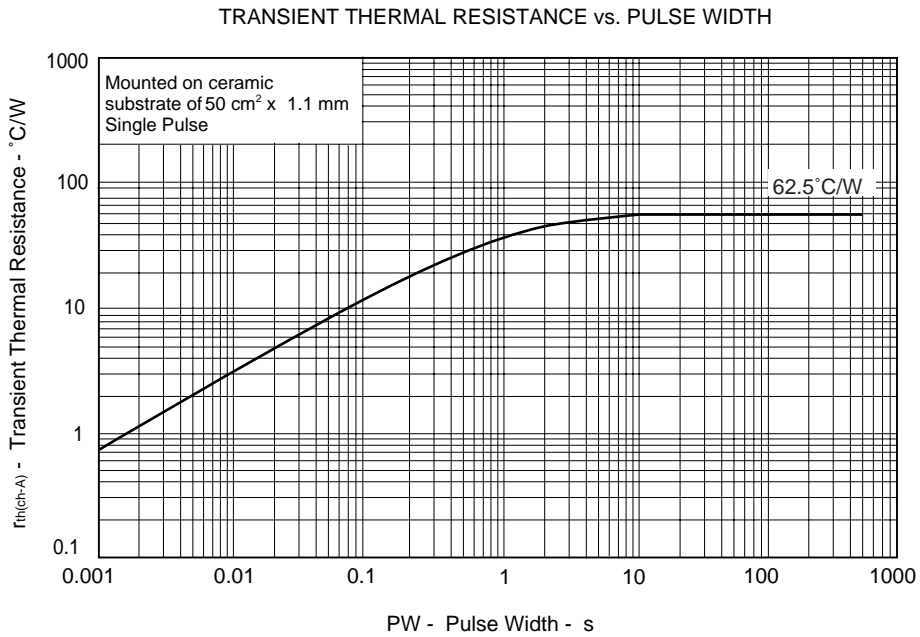
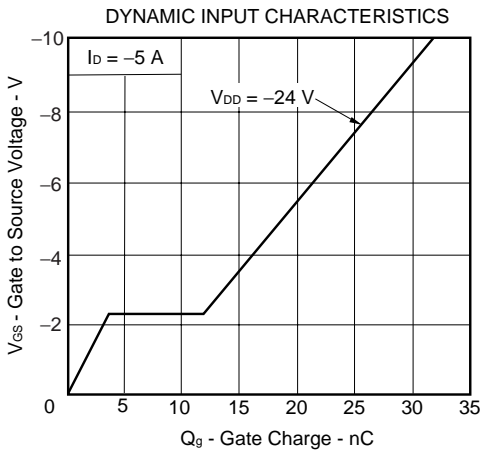
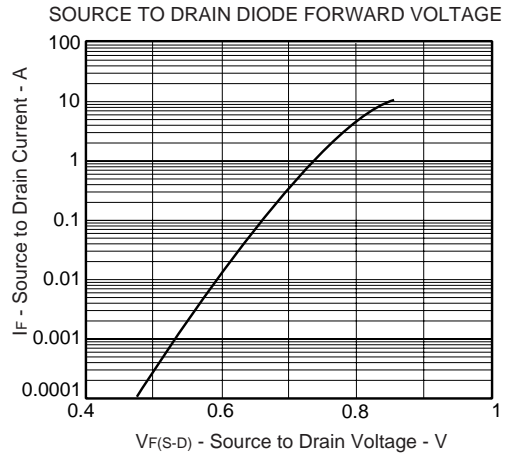
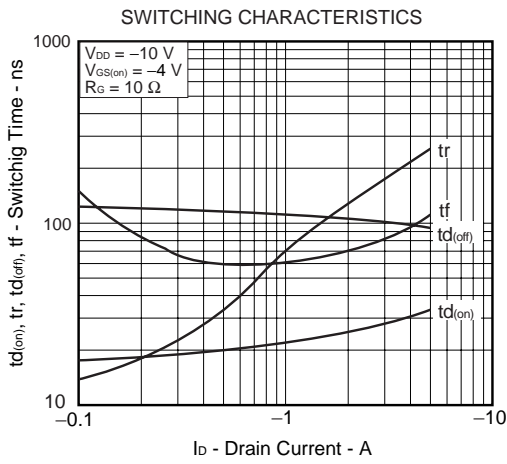
TEST CIRCUIT 2 GATE CHARGE



★ TYPICAL CHARACTERISTICS (T_A = 25 °C)







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